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# QN3102M6N N-Channel 30V Fast Switching MOSFET

## **General Description**

The QN3102M6N is a high performance trench N-channel MOSFET which utilizes extremely high cell density to provide low Rdson and gate charge characteristics. It is ideally suited to support synchronous buck converter applications.

The QN3102M6N meets RoHS and Green Product requirements while supporting full function reliability.

### **Features**

- ✓ Advanced high cell density Trench technology
- ✓ Super Low Gate Charge
- ✓ Green Device Available

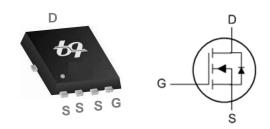
### **Product Summary**

V <sub>DS</sub>	R <sub>DS(ON)</sub> max (V <sub>GS</sub> =10V)	Ι <sub>D</sub> (Tc=25 °C)
30V	7.5mΩ	61A

### **Applications**

- ✓ High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- ✓ Networking DC-DC Power System
- ✓ Load Switch

## **Pin Configuration**

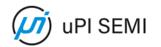


## **Ordering Information**

Order Number	Package Type	Top Marking		
QN3102M6N	PRPAK5X6	Q N 3 1 0 2 Product Name Weekly Code Logo Pin 1 dot Sequence Assembly Code		

#### QN3102M6N-DS-F0000, Dec. 2019

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# **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	30	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I₀@Tc=25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	61	А
I₀@Tc=100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	38	А
ID@TA=25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	13	А
ID@TA=70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	10	Α
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	122	Α
EAS	Single Pulse Avalanche Energy <sup>3</sup>	33	mJ
I <sub>AS</sub>	Avalanche Current	25.7	А
PD@Tc=25°C	Total Power Dissipation <sup>4</sup>	44	W
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation <sup>4</sup>	2.0	W
Tstg	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

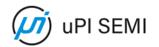
### **Thermal Data**

Symbol	Parameter		Max.	Unit
R <sub>0JA</sub>	Thermal Resistance Junction-Ambient <sup>1</sup>		62	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		2.8	°C/W



# **N-Channel Electrical Characteristics**

N-Channel Electrical Characteristics: (T <sub>J</sub> =25 $^\circ\!\mathbb{C}$ , unless otherwise noted)						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	30			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25°C, I <sub>D</sub> =1mA		0.015		V/°C
BV <sub>DSSt</sub>	Drain-Source Breakdown Voltage (transient)	$V_{GS}$ = 0 V, $I_{D(aval)}$ = 12.6 A, $T_{case}$ = 25°C, $t_{transient}$ = 100 ns	34			V
	Static Drain-Source	V <sub>GS</sub> =10V, I <sub>D</sub> =30A		6.0	7.5	
Rds(ON)	On-Resistance <sup>2</sup>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =15A		8.0	10.4	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage		1.2		2.5	V
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA		-3.9		mV/°C
-		V <sub>DS</sub> =24V, V <sub>GS</sub> =0V,T <sub>J</sub> =25°C			1	
ldss	Drain-Source Leakage Current	V <sub>DS</sub> =24V, V <sub>GS</sub> =0V,T <sub>J</sub> =55°C			5	- uA
lgss	Gate-Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =15A		26		S
Rg	Gate Resistance	V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1MHz		1.7		Ω
Qg	Total Gate Charge	V <sub>DS</sub> =15V, V <sub>GS</sub> =10V, I <sub>D</sub> =15A		10.5		
Qg	Total Gate Charge			5.0		nC
Qgs	Gate-Source Charge	V <sub>DS</sub> =15V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =15A		1.8		nc
$Q_gd$	Gate-Drain Charge			1.7		
t <sub>d(on)</sub>	Turn-On Delay Time			6.0		
tr	Rise Time	V <sub>DS</sub> =15V, V <sub>GS</sub> =10V, R <sub>G</sub> =3.3Ω,		44.8		
$t_{\text{d(off)}}$	Turn-Off Delay Time	I <sub>D</sub> =15A		13.5		ns
t <sub>f</sub>	Fall Time			2.5		
Ciss	Input Capacitance			571		
Coss	Output Capacitance	V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1MHz		210		pF
Crss	Reverse Transfer Capacitance			17		



## **Guaranteed Avalanche Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy⁵	$V_{\text{DD}}\text{=}25\text{V}$ , L=0.1mH , I_{\text{AS}}\text{=}19\text{A}	18.05		-	mJ

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current <sup>1,6</sup>	$V_G=V_D=0V$ , Force Current			61	А
Ism	Pulsed Source Current <sup>2,6</sup>				122	А
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V, I <sub>S</sub> =1A, T <sub>J</sub> =25°C			1.2	V
trr	Reverse Recovery Time	l⊧=15A, di/dt=100A/µs,		14		nS
Qrr	Reverse Recovery Charge	TJ=25°C		4		nC

Note:

1. Test data conducted with surface mount attachment to 1 inch<sup>2</sup>, FR-4 board utilizing 2oz copper

2. Pulse Test. Pulse width  $\ \leq\$  300uS, duty cycle  $\ \leq\$  2%

3. EAS data is a maximum rating. The test condition is  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH

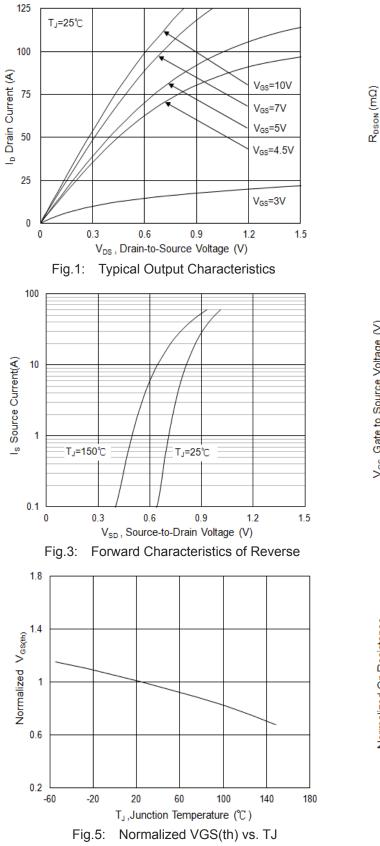
4. The power dissipation is limited by a 150°C maximum junction temperature

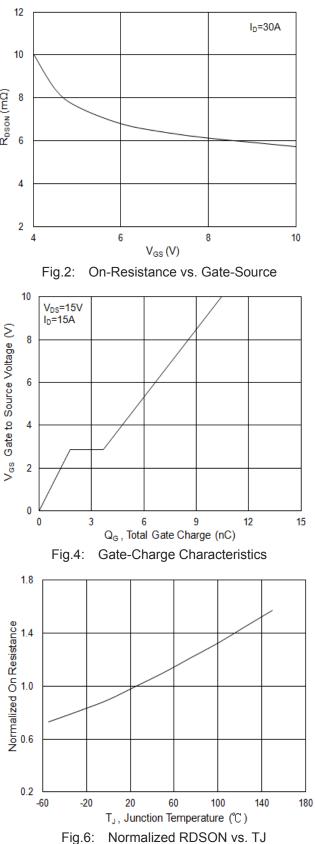
5. The Min. value is 100% EAS tested guarantee

6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ . In real applications, it will be limited by total power



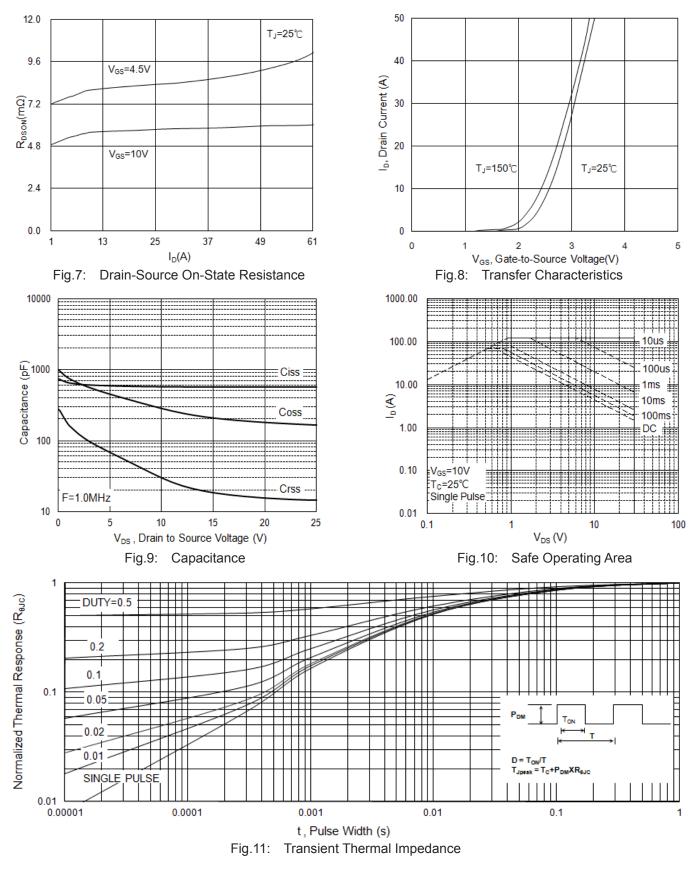
## **Typical Characteristics**



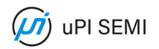


#### QN3102M6N-DS-F0000, Dec. 2019





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### uPI Semiconductor Corp.

9F.,No.5, Taiyuan 1st St. Zhubei City, Hsinchu, Taiwan, R.O.C. TEL : 886.3.560.1666 FAX : 886.3.560.1888